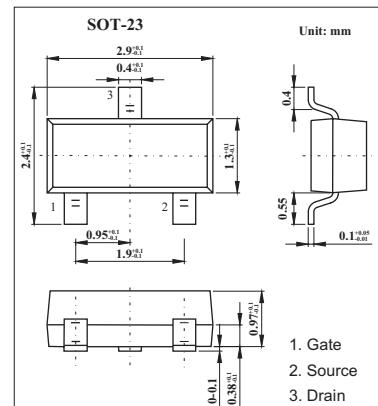
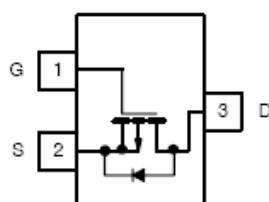


P-Channel 2.5-V (G-S) MOSFET

KI2301BDS

■ Features

- RoH Lead (Pb)-Free Version is RoHS Compliant.



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	5 sec	Steady State	Unit
Drain-Source Voltage	V _{DS}	-20		V
Gate-Source Voltage	V _{GS}	±8		V
Continuous Drain Current (T _J =150°C) *2 TA=25°C TA=70°C	I _D	-2.4 -1.9	-2.2 -1.8	A
Pulsed Drain Current *1	I _{DM}	-	-10	A
Continuous Source Current (diode conduction) *2	I _S	-0.72	-0.6	A
Power Dissipation *2 TA=25°C TA=70°C	P _D	0.9 0.57	0.7 0.45	W
Junction Temperature	T _j	-	150	°C
Storage Temperature	T _{stg}	-	-55 to +150	°C

* 1. Pulse width limited by maximum junction temperature.

* 2. Surface Mounted on FR4 Board, t ≤ 5 sec.

■ Thermal Resistance Ratings Ta = 25°C

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient *1	R _{thJA}	120	145	°C/W
Maximum Junction-to-Ambient *2		140	175	

* 1. Surface Mounted on FR4 Board, t ≤ 5 sec.

* 2. Surface Mounted on FR4 Board.

KI2301BDS■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{(\text{BR})DSS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	-0.45		-0.95	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA
		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$			-10	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \leq -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-6			A
		$V_{DS} \leq -5 \text{ V}, V_{GS} = -2.5 \text{ V}$	-3			
Drain-Source On-State Resistance *	$r_{DS(on)}$	$V_{GS} = -4.5 \text{ V}, I_D = -2.8 \text{ A}$		0.08	0.1	Ω
		$V_{GS} = -2.5 \text{ V}, I_D = -2.0 \text{ A}$		0.11	0.15	
Forward Transconductance *	g_{fs}	$V_{DS} = -5 \text{ V}, I_D = -2.8 \text{ A}$		6.5		S
Diode Forward Voltage *	V_{SD}	$I_S = -0.75 \text{ A}, V_{GS} = 0 \text{ V}$		-0.8	-1.2	V
Total Gate Charge	Q_g			4.5	10	nC
Gate-Source Charge	Q_{gs}	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -2.8 \text{ A}$		0.7		
Gate-Drain Charge	Q_{gd}			1.1		
Input Capacitance	C_{iss}	$V_{DS} = -6 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		375		pF
Output Capacitance	C_{oss}			95		
Reverse Transfer Capacitance	C_{rss}			65		
Turn-On Time	$t_{d(on)}$	$V_{DD} = -6 \text{ V}, R_L = 6 \Omega, I_D = -1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_G = 6 \Omega$		20	30	ns
	t_r			40	60	
Turn-Off Time	$t_{d(off)}$			30	45	
	t_f			20	30	

* Pulse test: $PW \leq 300 \mu\text{s}$ duty cycle $\leq 2\%$.

■ Marking

Marking	L1
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